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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LCD, POR, PWM, WDT
Number of I/O	53
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 16x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f65k90-i-ptrsl

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TABLE 1-3: PIC18F6XK90 PINOUT I/O DESCRIPTIONS (CONTINUED)

Din Nome	Pin Number	Pin	Buffer	Description
Pin Name	QFN/TQFP	Туре	Туре	Description
				PORTA is a bidirectional I/O port.
RA0/AN0/ULPWU RA0 AN0 ULPWU	24	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 0. Ultra Low-Power Wake-up (ULPW) input.
RA1/AN1/SEG18 RA1 AN1 SEG18	23	I/O I O	TTL Analog Analog	Digital I/O. Analog Input 1. SEG18 output for LCD.
RA2/AN2/VREF- RA2 AN2 VREF-	22	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 2. A/D reference voltage (low) input.
RA3/AN3/VREF+ RA3 AN3 VREF+	21	I/O I I	TTL Analog Analog	Digital I/O. Analog Input 3. A/D reference voltage (high) input.
RA4/T0CKI/SEG14 RA4 T0CKI SEG14	28	I/O I O	ST ST Analog	Digital I/O. Timer0 external clock input. SEG14 output for LCD.
RA5/AN4/SEG15/T1CKI/ T3G/HLVDIN RA5 AN4 SEG15 T1CKI T3G HLVDIN	27	I/O O I	TTL Analog Analog ST ST Analog	Digital I/O. Analog Input 4. SEG15 output for LCD. Timer1 clock input. Timer3 external clock gate input. High/Low-Voltage Detect (HLVD) input.
RA6 RA7				See the OSC2/CLKO/RA6 pin. See the OSC1/CLKI/RA7 pin.

Legend: TTL = TTL compatible input CMOS = CMOS compatible input or output

ST = Schmitt Trigger input with CMOS levels Analog = Analog input
I = Input O = Output

P = Power OD = Open-Drain (no P diode to VDD)

 $I^2C^{TM} = I^2C/SMBus$

Note 1: Default assignment for ECCP2 when the CCP2MX Configuration bit is set.

2: Alternate assignment for ECCP2 when the CCP2MX Configuration bit is cleared.

3: Not available on PIC18F65K90 and PIC18F85K90 devices.

3.0 OSCILLATOR CONFIGURATIONS

3.1 Oscillator Types

The PIC18F87K90 family of devices can be operated in the following oscillator modes:

• EC	External Clock, RA6 available
• ECIO	External Clock, Clock Out RA6 (Fosc/4 on RA6)
• HS	High-Speed Crystal/Resonator
 XT 	Crystal/Resonator
• LP	Low-Power Crystal
• RC	External Resistor/Capacitor, RA6 available
• RCIO	External Resistor/Capacitor, Clock Out RA6 (Fosc/4 on RA6)
• INTIO2	Internal Oscillator with I/O on RA6 and RA7
• INTIO1	Internal Oscillator with Fosc/4 Output on RA6 and I/O on RA7

There is also an option for running the 4xPLL on any of the clock sources in the input frequency range of 4 to 16 MHz.

The PLL is enabled by setting the PLLCFG bit (CONFIG1H<4>) or the PLLEN bit (OSCTUNE<6>).

For the EC and HS mode, the PLLEN (software) or PLLCFG (CONFIG) bit can be used to enable the PLL.

For the INTIOx modes (HF-INTOSC):

- Only the PLLEN can enable the PLL (PLLCFG is ignored).
- When the oscillator is configured for the internal oscillator (OSC<3:0> = 100x), the PLL can be enabled only when the HF-INTOSC frequency is 8 or 16 MHz.

When the RA6 and RA7 pins are not used for an oscillator function or CLKOUT function, they are available as general purpose I/Os.

To optimize power consumption when using EC/HS/XT/LP/RC as the primary oscillator, the frequency input range can be configured to yield an optimized power bias:

- Low-Power Bias External frequency less than 160 kHz
- Medium Power Bias External frequency between 160 kHz and 16 MHz
- High-Power Bias External frequency greater than 16 MHz

All of these modes are selected by the user by programming the OSC<3:0> Configuration bits (CONFIG1H<3:0>). In addition, PIC18F87K90 family devices can switch between different clock sources, either under software control or under certain conditions, automatically. This allows for additional power savings by managing device clock speed in real time without resetting the application. The clock sources for the PIC18F87K90 family of devices are shown in Figure 3-1.

For the HS and EC mode, there are additional power modes of operation – depending on the frequency of operation.

HS1 is the Medium Power mode with a frequency range of 4 MHz to 16 MHz. HS2 is the High-Power mode where the oscillator frequency can go from 16 MHz to 25 MHz. HS1 and HS2 are achieved by setting the CONFIG1H<3:0> correctly. (For details, see Register 28-2 on page 428.)

EC mode has these modes of operation:

- EC1 For low power with a frequency range up to 160 kHz
- EC2 Medium power with a frequency range of 160 kHz to 16 MHz
- EC3 High power with a frequency range of 16 MHz to 64 MHz

EC1, EC2 and EC3 are achieved by setting the CONFIG1H<3:0> correctly. (For details, see Register 28-2 on page 428.)

Table 3-1 shows the HS and EC modes' frequency range and OSC<3:0> settings.

REGISTER 4-4: PMD0: PERIPHERAL MODULE DISABLE REGISTER 0

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CCP3MD	CCP2MD	CCP1MD	UART2MD	UART1MD	SSP2MD	SSP1MD	ADCMD
bit 7							bit 0

Legend:

R = Readable bit W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 CCP3MD: PMD ECCP3 Enable/Disable bit

1 = Peripheral Module Disable (PMD) is enabled for ECCP3, disabling all of its clock sources

0 = PMD is disabled for ECCP3

bit 6 CCP2MD: PMD ECCP2 Enable/Disable bit

1 = PMD is enabled for ECCP2, disabling all of its clock sources

0 = PMD is disabled for ECCP2

bit 5 CCP1MD: PMD ECCP1 Enable/Disable bit

1 = PMD is enabled for ECCP1, disabling all of its clock sources

0 = PMD is disabled for ECCP1

bit 4 UART2MD: PMD UART2 Enable/Disable bit

1 = PMD is enabled for UART2, disabling all of its clock sources

0 = PMD is disabled for UART2

bit 3 UART1MD: PMD UART1 Enable/Disable bit

1 = PMD is enabled for UART1, disabling all of its clock sources

0 = PMD is disabled for UART1

bit 2 SSP2MD: PMD MSSP2 Enable/Disable bit

1 = PMD is enabled for MSSP2, disabling all of its clock sources

0 = PMD is disabled for MSSP2

bit 1 SSP1MD: PMD MSSP1 Enable/Disable bit

1 = PMD is enabled for MSSP1, disabling all of its clock sources

0 = PMD is disabled for MSSP1

bit 0 ADCMD: PMD Analog/Digital Converter PMD Enable/Disable bit

1 = PMD is enabled for Analog/Digital Converter, disabling all of its clock sources

0 = PMD is disabled for Analog/Digital Converter

TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F50h	CCPR2H	Capture/Com	npare/PWM R	egister 2 High	Byte					xxxx xxxx
F51h	ECCP2DEL	P2RSEN	P2DC6	P2DC5	P2DC4	P2DC3	P2DC2	P2DC1	P2DC0	0000 0000
F52h	ECCP2AS	ECCP2ASE	ECCP2AS2	ECCP2AS1	ECCP2AS0	PSS2AC1	PSS2AC0	PSS2BD1	PSS2BD0	0000 0000
F53h	PADCFG1	RDPU	REPU	RJPU ⁽²⁾	_	_	RTSECSEL1	RTSECSEL0	_	00000-
F54h	CM1CON	CON	COE	CPOL	EVPOL1	EVPOL0	CREF	CCH1	CCH0	0001 1111
F55h	CTMUICON	ITRIM5	ITRIM4	ITRIM3	ITRIM2	ITRIM1	ITRIM0	IRNG1	IRNG1	0000 0000
F56h	CTMUCONL	EDG2POL	EDG2SEL1	EDG2SEL0	EDG1POL	EDG1SEL1		EDG2STAT	EDG1STAT	0000 0000
F57h	CTMUCONH	CTMUEN	_	CTMUSIDL	TGEN	EDGEN	EDGSEQEN	IDISSEN	CTTRIG	0-00 0000
F58h	ALRMVALL		ı Hiah Reaister	Window base						0000 0000
F59h	ALRMVALH			Window base						xxxx xxxx
F5Ah	ALRMRPT	ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0	0000 0000
F5Bh	ALRMCFG	ALRMEN	CHIME	AMASK3	AMASK2	AMASK1	AMASK0	ALRMPTR1	ALRMPTR0	0000 0000
F5Ch	RTCVALL		l .	Window base			71171710110	/ LICINII II II	/ LI CONT TITO	0000 0000
F5Dh	RTCVALH			Window base						xxxx xxxx
F5Eh	RTCCAL	CAL7	CAL6	CAL5	CAL4	CAL3	CAL2	CAL1	CAL0	XXXX XXXX
F5Fh	RTCCFG	RTCEN		RTCWREN	RTCSYNC	HALFSEC	RTCOE	RTCPTR1	RTCPTR0	0-00 0000
F60h	PIE6	KICLIN		KICWKLN	EEIE	TIALI SLC	CMP3IE	CMP2IE	CMP1IE	0 -000
		EEDDOM Do	to Posistor	_	EEIE	_	CIVIF3IE	CIVIFZIE	CIVIF IIE	0000 0000
F61h	EEDATA	EEPROM Da		ar Laur Durta						
F62h	EEADR		Idress Registe							0000 0000
F63h	EEADRH	EEPROM AO	Idress Registe	r High Byte		000000		MEIOEO	MEIOOFI	00
F64h	OSCCON2		SOSCRUN	- DVDTD	TVOVD	SOSCGO	_	MFIOFS	MFIOSEL	-0 0-x0
F65h	BAUDCON1	ABDOVF	RCIDL	RXDTP	TXCKP	BRG16	_	WUE	ABDEN	0000 0-x0
F66h	LCDDATA0	S07C0	S06C0	S05C0	S04C0	S03C0	S02C0	S01C0	S00C0	XXXX XXXX
F67h	LCDDATA1	S15C0	S14C0	S13C0	S12C0	S11C0	S10C0	S09C0	S08C0	XXXX XXXX
F68h	LCDDATA2	S23C0	S22C0	S21C0	S20C0	S19C0	S18C0	S17C0	S16C0	XXXX XXXX
F69h	LCDDATA3	S31C0	S30C0	S29C0	S28C0	S27C0	S26C0	S25C0	S24C0	XXXX XXXX
F6Ah	LCDDATA4	S39C0	S38C0	S37C0	S36C0	S35C0	S34C0	S33C0	S32C0	XXXX XXXX
F6Bh	LCDDATA5	S47C0	S46C0	S45C0	S44C0	S43C0	S42C0	S41C0	S40C0	XXXX XXXX
F6Ch	LCDDATA6	S07C1	S06C1	S05C1	S04C1	S03C1	S02C1	S01C1	S00C1	XXXX XXXX
F6Dh	LCDDATA7	S15C1	S14C1	S13C1	S12C1	S11C1	S10C1	S09C1	S08C1	XXXX XXXX
F6Eh	LCDDATA8	S23C1	S22C1	S21C1	S20C1	S19C1	S18C1	S17C1	S16C1	xxxxxxxx
F6Fh	LCDDATA9	S31C1	S30C1	S29C1	S28C1	S27C1	S26C1	S25C1	S24C1	xxxx xxxx
F70h	LCDDATA10 ⁽²⁾	S39C1 ⁽²⁾	S38C1 ⁽²⁾	S37C1 ⁽²⁾	S36C1 ⁽²⁾	S35C1 ⁽²⁾	S34C1 ⁽²⁾	S33C1 ⁽²⁾	S32C1	xxxx xxxx
F71h	LCDDATA11 ⁽²⁾	S47C1	S46C1	S45C1	S44C1	S43C1	S42C1	S41C1	S40C1	xxxx xxxx
F72h	LCDDATA12	S07C2	S06C2	S05C2	S04C2	S03C2	S02C2	S01C2	S00C2	xxxx xxxx
F73h	LCDDATA13	S15C2	S14C2	S13C2	S12C2	S11C2	S10C2	S09C2	S08C2	xxxx xxxx
F74h	LCDDATA14	S23C2	S22C2	S21C2	S20C2	S19C2	S18C2	S17C2	S16C2	xxxx xxxx
F75h	LCDDATA15	S31C2	S30C2	S29C2	S28C2	S27C2	S26C2	S25C2	S24C2	xxxx xxxx
F76h	LCDDATA16 ⁽²⁾	S39C2 ⁽²⁾	S38C2 ⁽²⁾	S37C2 ⁽²⁾	S36C2 ⁽²⁾	S35C2 ⁽²⁾	S34C2 ⁽²⁾	S33C2 ⁽²⁾	S32C2	xxxx xxxx
F77h	LCDDATA17 ⁽²⁾	S47C2	S46C2	S45C2	S44C2	S43C2	S42C2	S41C2	S40C2	xxxx xxxx
F78h	LCDDATA18	S07C3	S06C3	S05C3	S04C3	S03C3	S02C3	S01C3	S00C3	xxxx xxxx
F79h	LCDDATA19	S15C3	S14C3	S13C3	S12C3	S11C3	S10C3	S09C3	S08C3	xxxx xxxx
F7Ah	LCDDATA20	S23C3	S22C3	S21C3	S20C3	S19C3	S18C3	S17C3	S16C3	xxxx xxxx
F7Bh	LCDDATA21	S31C3	S30C3	S29C3	S28C3	S27C3	S26C3	S25C3	S24C3	xxxx xxxx
F7Ch	LCDDATA22	S39C3 ⁽²⁾	S38C3 ⁽²⁾	S37C3 ⁽²⁾	S36C3 ⁽²⁾	S35C3 ⁽²⁾	S34C3 ⁽²⁾	S33C3 ⁽²⁾	S32C3	xxxx xxxx
F7Dh	LCDDATA23 ⁽²⁾	S47C3	S46C3	S45C3	S44C3	S43C3	S42C3	S41C3	S40C3	xxxx xxxx
F7Eh	EECON2		l .	2 (not a phys						
F7Fh	EECON1	EEPGD	CFGS	_	FREE	WRERR	WREN	WR	RD	xx-0 x000
F80h	PORTA	RA7	RA6	RA5	RA4	RA3	RA2	RA1	RA0	xxxx xxxx

Note 1: This bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, the bit is unimplemented.

^{2:} Unimplemented in 64-pin devices (PIC18F6XK90).

^{3:} Unimplemented in devices with a program memory of 32 Kbytes (PIC18FX5K90).

TABLE 6-2: PIC18F87K90 FAMILY REGISTER FILE SUMMARY (CONTINUED)

Address	File Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR
F81h	PORTB	RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	xxxx xxxx
F82h	PORTC	RC7	RC6	RC5	RC4	RC3	RC2	RC1	RC0	xxxx xxxx
F83h	PORTD	RD7	RD6	RD5	RD4	RD3	RD2	RD1	RD0	xxxx xxxx
F84h	PORTE	RE7	RE6	RE5	RE4	RE3	RE2	RE1	RE0	xxxx xxxx
F85h	PORTF	RF7	RF6	RF5	RF4	RF3	RF2	RF1	_	xxxx xxx-
F86h	PORTG	_	_	RG5 ⁽¹⁾	RG4	RG3	RG2	RG1	RG0	xx xxxx
F87h	PORTH ⁽²⁾	RH7	RH6	RH5	RH4	RH3	RH2	RH1	RH0	xxxx xxxx
F88h	PORTJ ⁽²⁾	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	xxxx xxxx
F89h	LATA	LATA7	LATA6	LATA5	LATA4	LATA3	LATA2	LATA1	LATA0	xxxx xxxx
F8Ah	LATB	LATB7	LATB6	LATB5	LATB4	LATB3	LATB2	LATB1	LATB0	xxxx xxxx
F8Bh	LATC	LATC7	LATC6	LATC5	LATC4	LATC3	LATC2	LATC1	LATC0	xxxx xxxx
F8Ch	LATD	LATD7	LATD6	LATD5	LATD4	LATD3	LATD2	LATD1	LATD0	xxxx xxxx
F8Dh	LATE	LATE7	LATE6	LATE5	LATE4	LATE3	LATE2	LATE1	LATE0	xxxx xxxx
F8Eh	LATF	LATF7	LATF6	LATF5	LATF4	LATF3	LATF2	LATF1	_	xxxx xxx-
F8Fh	LATG	_	_	_	LATG4	LATG3	LATG2	LATG1	LATG0	x xxxx
F90h	LATH ⁽²⁾	LATH7	LATH6	LATH5	LATH4	LATH3	LATH2	LATH1	LATH0	xxxx xxxx
F91h	LATJ ⁽²⁾	LATJ7	LATJ6	LATJ5	LATJ4	LATJ3	LATJ2	LATJ1	LATJ0	xxxx xxxx
F92h	TRISA	TRISA7	TRISA6	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0	1111 1111
F93h	TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	1111 1111
F94h	TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	1111 1111
F95h	TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	1111 1111
F96h	TRISE	TRISE7	TRISE6	TRISE5	TRISE4	TRISE3	TRISE2	TRISE1	TRISE0	1111 1111
F97h	TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	1111 111-
F98h	TRISG	_	_	_	TRISG4	TRISG3	TRISG2	TRISG1	TRISG0	1 1111
F99h	TRISH ⁽²⁾	TRISH7	TRISH6	TRISH5	TRISH4	TRISH3	TRISH2	TRISH1	TRISH0	1111 1111
F9Ah	TRISJ ⁽²⁾	TRISJ7	TRISJ6	TRISJ5	TRISJ4	TRISJ3	TRISJ2	TRISJ1	TRISJ0	1111 1111
F9Bh	OSCTUNE	INTSRC	PLLEN	TUN5	TUN4	TUN3	TUN2	TUN1	TUN0	0000 0000
F9Ch	PSTR1CON	CMPL1	CMPL0	_	STRSYNC	STRD	STRC	STRB	STRA	00-0 0001
F9Dh	PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	-000 0000
F9Eh	PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	-000 0000
F9Fh	IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	-111 1111
FA0h	PIE2	OSCFIE	_	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	0-10 0000
FA1h	PIR2	OSCFIF	_	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	0-10 0000
FA2h	IPR2	OSCFIP	_	SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	1-00 1110
	PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	0000 0000
FA4h	PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	0000 0000
FA5h	IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	1111 1111
FA6h	PIR6	_	_	_	EEIF	_	CMP3IF	CMP2IF	CMP1IF	0 -000
FA7h	_	_	_	_	_	_	_	_	_	
FA8h	HLVDCON	VDIRMAG	BGVST	IRVST	HLVDEN	HLVDL3	HLVDL2	HLVDL1	HLVDL0	0000 0000
FA9h	IPR6	_	_	_	EEIP	_	CMP3IP	CMP2IP	CMP1IP	1 -111
FAAh	T1GCON	TMR1GE	T1GPOL	T1GTM	T1GSPM	T1GGO/ T1DONE	T1GVAL	T1GSS1	T1GSS0	0000 0x00
FABh	RCSTA1	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 000x
FACh	TXSTA1	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010
FADh	TXREG1		nsmit Registe		1	1	1	1	1	xxxx xxxx
FAEh	RCREG1	USART1 Red	eive Register							0000 0000
FAFh	SPBRG1		ıd Rate Gene							0000 0000

Note 1: This bit is available when Master Clear is disabled (MCLRE = 0). When MCLRE is set, the bit is unimplemented.

^{2:} Unimplemented in 64-pin devices (PIC18F6XK90).

^{3:} Unimplemented in devices with a program memory of 32 Kbytes (PIC18FX5K90).

TABLE 10-1: SUMMARY OF REGISTERS ASSOCIATED WITH INTERRUPTS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	75
INTCON2	RBPU	INTEDG0	INTEDG1	INTEDG2	INTEDG3	TMR0IP	INT3IP	RBIP	75
INTCON3	INT2IP	INT1IP	INT3IE	INT2IE	INT1IE	INT3IF	INT2IF	INT1IF	75
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	77
PIR2	OSCFIF	_	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	77
PIR3	TMR5GIF	LCDIF	RC2IF	TX2IF	CTMUIF	CCP2IF	CCP1IF	RTCCIF	77
PIR4	CCP10IF ⁽¹⁾	CCP9IF ⁽¹⁾	CCP8IF	CCP7IF	CCP6IF	CCP5IF	CCP4IF	CCP3IF	77
PIR5	TMR7GIF ⁽¹⁾	TMR12IF ⁽¹⁾	TMR10IF ⁽¹⁾	TMR8IF	TMR7IF ⁽¹⁾	TMR6IF	TMR5IF	TMR4IF	77
PIR6	_	_		EEIF	_	CMP3IF	CMP2IF	CMP1IF	77
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	77
PIE2	OSCFIE	_	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	77
PIE3	TMR5GIE	LCDIE	RC2IE	TX2IE	CTMUIE	CCP2IE	CCP1IE	RTCCIE	77
PIE4	CCP10IE ⁽¹⁾	CCP9IE ⁽¹⁾	CCP8IE	CCP7IE	CCP6IE	CCP5IE	CCP4IE	CCP3IE	77
PIE5	TMR7GIE ⁽¹⁾	TMR12IE ⁽¹⁾	TMR10IE ⁽¹⁾	TMR8IE	TMR7IE ⁽¹⁾	TMR6IE	TMR5IE	TMR4IE	77
PIE6	_		1	EEIE		CMP3IE	CMP2IE	CMP1IE	80
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	77
IPR2	OSCFIP	_	SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	77
IPR3	TMR5GIP	LCDIP	RC2IP	TX2IP	CTMUIP	CCP2IP	CCP1IP	RTCCIP	77
IPR4	CCP10IP ⁽¹⁾	CCP9IP ⁽¹⁾	CCP8IP	CCP7IP	CCP6IP	CCP5IP	CCP4IP	CCP3IP	77
IPR5	TMR7GIP ⁽¹⁾	TMR12IP ⁽¹⁾	TMR10IP ⁽¹⁾	TMR8IP	TMR7IP ⁽¹⁾	TMR6IP	TMR5IP	TMR4IP	76
IPR6	_	_	_	EEIP		CMP3IP	CMP2IP	CMP1IP	77
RCON	IPEN	SBOREN	CM	RI	TO	PD	POR	BOR	76

Legend: Shaded cells are not used by the interrupts.

Note 1: Unimplemented in devices with a program memory of 32 Kbytes (PIC18FX5K90).

REGISTER 11-2: ODCON2: PERIPHERAL OPEN-DRAIN CONTROL REGISTER 2

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CCP10OD ⁽¹⁾	CCP9OD ⁽¹⁾	CCP8OD	CCP7OD	CCP6OD	CCP5OD	CCP4OD	CCP3OD
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7	CCP10OD: CCP10 Open-Drain Output Enable bit ⁽¹⁾
	1 = Open-drain capability is enabled0 = Open-drain capability is disabled
bit 6	CCP9OD: CCP9 Open-Drain Output Enable bit(1)
	1 = Open-drain capability is enabled0 = Open-drain capability is disabled
bit 5	CCP8OD: CCP8 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled0 = Open-drain capability is disabled
bit 4	CCP7OD: CCP7 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled0 = Open-drain capability is disabled
bit 3	CCP6OD: CCP6 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled0 = Open-drain capability is disabled
bit 2	CCP5OD: CCP5 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled0 = Open-drain capability is disabled
bit 1	CCP4OD: CCP4 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled0 = Open-drain capability is disabled
bit 0	CCP3OD: ECCP3 Open-Drain Output Enable bit
	1 = Open-drain capability is enabled0 = Open-drain capability is disabled

Note 1: Unimplemented in devices with a program memory of 32 Kbytes (PIC18FX5K90).

11.5 PORTD, TRISD and LATD Registers

PORTD is an 8-bit wide, bidirectional port. The corresponding Data Direction and Output Latch registers are TRISD and LATD.

All pins on PORTD are implemented with Schmitt Trigger input buffers. Each pin is individually configurable as an input or output.

Note: These pins are configured as digital inputs on any device Reset.

Each of the PORTD pins has a weak internal pull-up. A single control bit can turn off all the pull-ups. This is performed by clearing bit, RDPU (PADCFG1<7>). The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on all device Resets.

All of the PORTD pins are multiplexed with LCD segment drives that are controlled by bits in the LCDSE0 register. RD0 is multiplexed with the CTMU pulse generator output.

I/O port functionality is only available when the LCD segments are disabled.

The PORTD also has the I²C and SPI functionality on RD4, RD5 and RD6. The pins for SPI are also configurable for open-drain output. Open-drain configuration is selected by setting the SSPxOD control bits in the ODCON1 register.

RD0 has a CTMU functionality. RD1 has the functionality for a Timer5 clock input and also Timer7 has functionality for an external clock gate input.

EXAMPLE 11-4: INITIALIZING PORTD

CLRF	PORTD	; Initialize PORTD by ; clearing output
		; data latches
		/ data factites
CLRF	LATD	; Alternate method
		; to clear output
		; data latches
MOVLW	0CFh	; Value used to
		; initialize data
		; direction
MOVWF	TRISD	; Set RD<3:0> as inputs
		; RD<5:4> as outputs
		; RD<7:6> as inputs
		_

TABLE 18-5: REGISTERS ASSOCIATED WITH CAPTURE, COMPARE, TIMER1/3/5/7 (CONTINUED)

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
CCP6CON	_	_	DC6B1	DC6B0	CCP6M3	CCP6M2	CCP6M1	CCP6M0	82
CCP7CON	_	_	DC7B1	DC7B0	CCP7M3	CCP7M2	CCP7M1	CCP7M0	82
CCP8CON	_	_	DC8B1	DC8B0	CCP8M3	CCP8M2	CCP8M1	CCP8M0	80
CCP9CON ⁽¹⁾	_	_	DC9B1	DC9B0	ССР9М3	CCP9M2	CCP9M1	ССР9М0	80
CCP10CON ⁽¹⁾	_	_	DC10B1	DC10B0	CCP10M3	CCP10M2	CCP10M1	CCP10M0	81
CCPTMRS1	C7TSEL1	C7TSEL0	_	C6TSEL0	_	C5TSEL0	C4TSEL1	C4TSEL0	81
CCPTMRS2		_	_	C10TSEL0	_	C9TSEL0	C8TSEL1	C8TSEL0	81

Legend: — = unimplemented, read as '0'. Shaded cells are not used by Capture/Compare or Timer1/3/5/7.

Note 1: Unimplemented in devices with a program memory of 32 Kbytes (PIC18FX5K90).

2: Unimplemented in 64-pin devices.

18.4 **PWM Mode**

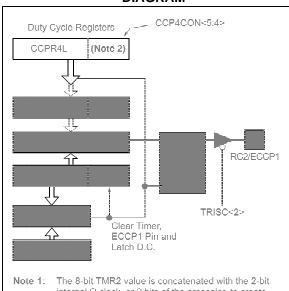
In Pulse-Width Modulation (PWM) mode, the CCP4 pin produces up to a 10-bit resolution PWM output. Since the CCP4 pin is multiplexed with a PORTC or PORTE data latch, the appropriate TRIS bit must be cleared to make the CCP4 pin an output.

Clearing the CCP4CON register will force Note: the RC1 or RE7 output latch (depending on device configuration) to the default low level. This is not the PORTC or PORTE I/O data latch.

Figure 18-3 shows a simplified block diagram of the ECCP1 module in PWM mode.

For a step-by-step procedure on how to set up the CCP module for PWM operation, see Section 18.4.3 "Setup for PWM Operation".

FIGURE 18-3: SIMPLIFIED PWM BLOCK **DIAGRAM**



- internal O clock, or 2 bits of the prescaler, to create the 10-bit time base.
 - 2: CCP4 and its appropriate timers are used as an example. For details on all of the CCP modules and their timer assignments, see Table 18-2 and Table 18-3.

21.3.1 REGISTERS

Each MSSP module has four registers for SPI mode operation. These are:

- MSSPx Control Register 1 (SSPxCON1)
- MSSPx Status Register (SSPxSTAT)
- · Serial Receive/Transmit Buffer Register (SSPxBUF)
- MSSPx Shift Register (SSPxSR) Not directly accessible

SSPxCON1 and SSPxSTAT are the control and status registers in SPI mode operation. The SSPxCON1 register is readable and writable. The lower 6 bits of the SSPxSTAT are read-only. The upper two bits of the SSPxSTAT are read/write.

SSPxSR is the shift register used for shifting data in or out. SSPxBUF is the buffer register to which data bytes are written to or read from.

In receive operations, SSPxSR and SSPxBUF together create a double-buffered receiver. When SSPxSR receives a complete byte, it is transferred to SSPxBUF and the SSPxIF interrupt is set.

transmission, the SSPxBUF double-buffered. A write to SSPxBUF will write to both SSPxBUF and SSPxSR.

The SSPxBUF register cannot be used with read-modify-write instructions, such as BCF, COMF, etc.

> To avoid lost data in Master mode, a read of the SSPxBUF must be performed to clear the Buffer Full (BF) detect bit (SSPxSTAT<0>) between each transmission.

REGISTER 21-1: SSPxSTAT: MSSPx STATUS REGISTER (SPI MODE)

R/W-0	R/W-0	R-0	R-0	R-0	R-0	R-0	R-0
SMP	CKE ⁽¹⁾	D/Ā	Р	S	R/W	UA	BF
bit 7							bit 0

R = Readable bit

Legend:

W = Writable bit U = Unimplemented bit, read as '0'

-n = Value at POR '1' = Bit is set '0' = Bit is cleared x = Bit is unknown

bit 7 SMP: Sample bit

SPI Master mode:

1 = Input data sampled at the end of data output time

0 = Input data sampled at the middle of data output time

SPI Slave mode:

SMP must be cleared when SPI is used in Slave mode.

CKE: SPI Clock Select bit(1) bit 6

1 = Transmit occurs on transition from active to Idle clock state

0 = Transmit occurs on transition from Idle to active clock state

bit 5 D/A: Data/Address bit

Used in I^2C^{TM} mode only.

bit 4

Used in I²C mode only. This bit is cleared when the MSSPx module is disabled; SSPEN is cleared.

bit 3 S: Start bit

Used in I²C mode only.

R/W: Read/Write Information bit bit 2

Used in I²C mode only.

UA: Update Address bit bit 1

Used in I²C mode only.

bit 0 BF: Buffer Full Status bit (Receive mode only)

1 = Receive complete. SSPxBUF is full

0 = Receive not complete, SSPxBUF is empty

Note 1: Polarity of the clock state is set by the CKP bit (SSPxCON1<4>).

21.3.9 OPERATION IN POWER-MANAGED MODES

In SPI Master mode, module clocks may be operating at a different speed than when in full-power mode; in the case of the Sleep mode, all clocks are halted.

In Idle modes, a clock is provided to the peripherals. That clock can be from the primary clock source, the secondary clock (SOSC oscillator) or the INTOSC source. See **Section 3.3 "Clock Sources and Oscillator Switching"** for additional information.

In most cases, the speed that the master clocks SPI data is not important; however, this should be evaluated for each system.

If MSSP interrupts are enabled, they can wake the controller from Sleep mode, or one of the Idle modes, when the master completes sending data. If an exit from Sleep or Idle mode is not desired, MSSP interrupts should be disabled.

If the Sleep mode is selected, all module clocks are halted and the transmission/reception will remain in that state until the device wakes. After the device returns to Run mode, the module will resume transmitting and receiving data.

In SPI Slave mode, the SPI Transmit/Receive Shift register operates asynchronously to the device. This allows the device to be placed in any power-managed mode and data to be shifted into the SPI Transmit/Receive Shift register. When all 8 bits have been received, the MSSP interrupt flag bit will be set, and if enabled, will wake the device.

21.3.10 EFFECTS OF A RESET

A Reset disables the MSSP module and terminates the current transfer.

21.3.11 BUS MODE COMPATIBILITY

Table 21-1 shows the compatibility between the standard SPI modes and the states of the CKP and CKF control bits

TABLE 21-1: SPI BUS MODES

Standard SPI Mode	Control Bits State				
Terminology	СКР	CKE			
0, 0	0	1			
0, 1	0	0			
1, 0	1	1			
1, 1	1	0			

There is also an SMP bit which controls when the data is sampled.

21.3.12 SPI CLOCK SPEED AND MODULE INTERACTIONS

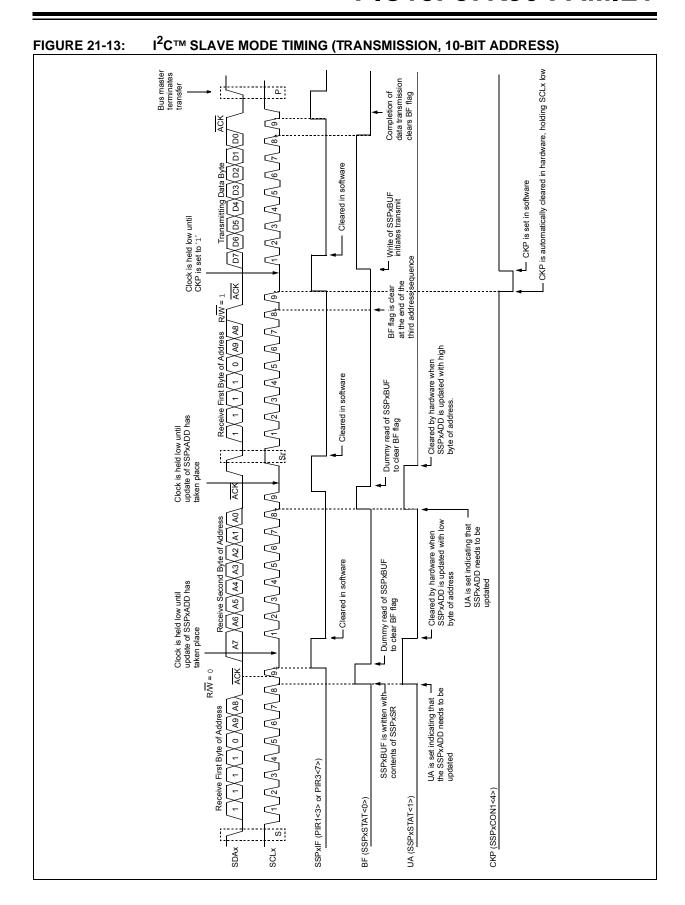
Because MSSP1 and MSSP2 are independent modules, they can operate simultaneously at different data rates. Setting the SSPM<3:0> bits of the SSPxCON1 register determines the rate for the corresponding module.

An exception is when both modules use Timer2 as a time base in Master mode. In this instance, any changes to the Timer2 module's operation will affect both MSSP modules equally. If different bit rates are required for each module, the user should select one of the other three time base options for one of the modules.

TABLE 21-2: REGISTERS ASSOCIATED WITH SPI OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Reset Values on Page:
INTCON	GIE/GIEH	PEIE/GIEL	TMR0IE	INT0IE	RBIE	TMR0IF	INT0IF	RBIF	75
PIR1	_	ADIF	RC1IF	TX1IF	SSP1IF	TMR1GIF	TMR2IF	TMR1IF	77
PIE1	_	ADIE	RC1IE	TX1IE	SSP1IE	TMR1GIE	TMR2IE	TMR1IE	77
IPR1	_	ADIP	RC1IP	TX1IP	SSP1IP	TMR1GIP	TMR2IP	TMR1IP	77
PIR2	OSCFIF	_	SSP2IF	BCL2IF	BCL1IF	HLVDIF	TMR3IF	TMR3GIF	77
PIE2	OSCFIE	_	SSP2IE	BCL2IE	BCL1IE	HLVDIE	TMR3IE	TMR3GIE	77
IPR2	OSCFIP	_	SSP2IP	BCL2IP	BCL1IP	HLVDIP	TMR3IP	TMR3GIP	77
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	78
TRISD	TRISD7	TRISD6	TRISD5	TRISD4	TRISD3	TRISD2	TRISD1	TRISD0	78
TRISF	TRISF7	TRISF6	TRISF5	TRISF4	TRISF3	TRISF2	TRISF1	_	78
SSP1BUF	MSSP1 Rec	eive Buffer/Tra	ansmit Regis	ster					82
SSP1CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	76
SSP1CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	76
SSP1STAT	SMP	CKE	D/A	Р	S	R/W	UA	BF	76
SSP2CON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	82
SSP2CON2	GCEN	ACKSTAT	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN	83
SSP2STAT	SMP	CKE	D/Ā	Р	S	R/W	UA	BF	82
SSP2BUF	MSSP2 Rec	eive Buffer/Tra	ansmit Regis	ster					82
ODCON3	U2OD	U1OD	_	_	_	_	_	CTMUDS	81

Legend: Shaded cells are not used by the MSSP module in SPI mode.



23.7 A/D Conversions

Figure 23-6 shows the operation of the A/D Converter after the GO/DONE bit has been set and the ACQT<2:0> bits are cleared. A conversion is started after the following instruction to allow entry into Sleep mode before the conversion begins.

Figure 23-7 shows the operation of the A/D Converter after the GO/DONE bit has been set, the ACQT<2:0> bits set to '010' and a 4 TAD acquisition time selected.

Clearing the GO/DONE bit during a conversion will abort the current conversion. The A/D Result register pair will NOT be updated with the partially completed A/D conversion sample. This means the

ADRESH:ADRESL registers will continue to contain the value of the last completed conversion (or the last value written to the ADRESH:ADRESL registers).

After the A/D conversion is completed or aborted, a 2 TAD Wait is required before the next acquisition can be started. After this Wait, acquisition on the selected channel is automatically started.

Note: The GO/DONE bit should **NOT** be set in the same instruction that turns on the A/D.

FIGURE 23-6: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 000, TACQ = 0)

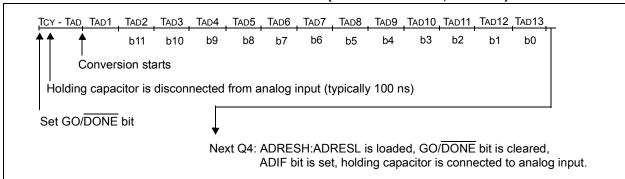
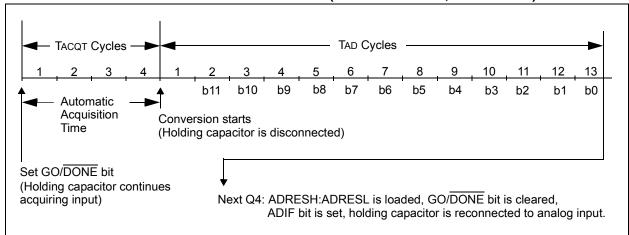


FIGURE 23-7: A/D CONVERSION TAD CYCLES (ACQT<2:0> = 010, TACQ = 4 TAD)



27.7 Creating a Delay with the CTMU Module

A unique feature on board the CTMU module is its ability to generate system clock independent output pulses, based on either an internal voltage or an external capacitor value. When using an external voltage, this is accomplished using the CTDIN input pin as a trigger for the pulse delay. When using an internal capacitor value, this is accomplished using the internal comparator voltage reference module and Comparator 2 input pin. The pulse is output onto the CTPLS pin. To enable this mode, set the TGEN bit.

See Figure 27-4 for an example circuit. When CTMUDS (ODCON3<0>) is cleared, the pulse delay is determined by the output of Comparator 2, and when it is set, the pulse delay is determined by the input of CTDIN. CDELAY is chosen by the user to determine the output pulse width on CTPLS. The pulse width is calculated by T = (CDELAY/I) * V, where I is known from the current source measurement step (Section 27.4.1 "Current Source Calibration") and V is the internal reference voltage (CVREF).

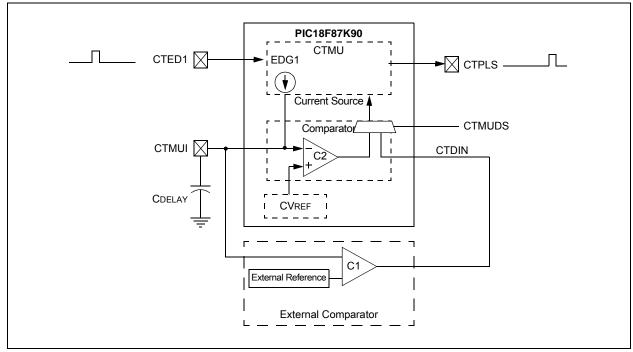
An example use of the external capacitor feature is interfacing with variable capacitive-based sensors, such as a humidity sensor. As the humidity varies, the pulse-width output on CTPLS will vary. An example use of the CTDIN feature is interfacing with a digital sensor. The CTPLS output pin can be connected to an input capture pin and the varying pulse width measured to determine the humidity in the application.

To use this feature:

- 1. If CTMUDS is cleared, initialize Comparator 2.
- If CTMUDS is cleared, initialize the comparator voltage reference.
- 3. Initialize the CTMU and enable time delay generation by setting the TGEN bit.
- 4. Set EDG1STAT.

When CTMUDS is cleared, as soon as CDELAY charges to the value of the voltage reference trip point, an output pulse is generated on CTPLS. When CTMUDS is set, as soon as CTDIN is set, an output pulse is generated on CTPLS.

FIGURE 27-4: TYPICAL CONNECTIONS AND INTERNAL CONFIGURATION FOR PULSE DELAY GENERATION



NEGF Negate f NEGF f {,a} Syntax: Operands: $0 \le f \le 255$ $a \in [0,1]$ Operation: $(\overline{f}) + 1 \rightarrow f$ N, OV, C, DC, Z Status Affected: Encoding: 0110 110a ffff ffff Description: Location 'f' is negated using two's complement. The result is placed in the data memory location 'f'.

If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the

GPR bank.

If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \le 95$ (5Fh). See Section 29.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed

Literal Offset Mode" for details.

Words: 1 Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read	Process	Write
	register 'f'	Data	register 'f'

Example: NEGF REG, 1

Before Instruction

REG = 0011 1010 [3Ah]

After Instruction

REG = 1100 0110 [C6h]

NOP		No Operation							
Synta	ax:	NOP							
Oper	ands:	None	None						
Oper	ation:	No operati	on						
Statu	s Affected:	None							
Enco	oding:	0000	0000	000	0	0000			
		1111	xxxx	XXX	ΧX	xxxx			
Desc	ription:	No operati	No operation.						
Word	ds:	1	1						
Cycle	es:	1	1						
QC	ycle Activity:								
	Q1	Q2	Q	3		Q4			
	Decode	No	No	No		No			
		operation	opera	tion	op	eration			

Example:

None.

31.2 DC Characteristics: Power-Down and Supply Current PIC18F87K90 Family (Industrial/Extended) (Continued)

PIC18F87K90 Family		Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \le \text{TA} \le +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \le \text{TA} \le +125^{\circ}\text{C}$ for extended							
Param No.	Device	Тур	Max	Units	Conditions				
	Supply Current (IDD) ^(2,3)								
	All devices	5.3	10	μА	-40°C				
		5.5	10	μА	+25°C	V _{DD} = 1.8V ⁽⁴⁾			
		5.5	10	μА	+85°C	Regulator Disabled			
		12	24	μА	+125°C				
	All devices	10	15	μΑ	-40°C		F 04111		
		10	16	μΑ	+25°C	1 VDD = 3.3 V/(3)	Fosc = 31 kHz (RC_RUN mode,		
		11	17	μΑ	+85°C	Regulator Disabled	LF-INTOSC)		
		15	35	μА	+125°C		2		
	All devices	70	180	μА	-40°C				
		80	185	μА	+25°C	$V_{DD} = 5V^{(5)}$			
		90	190	μА	+85°C	Regulator Enabled			
		200	500	μА	+125°C				
	All devices	410	850	μА	-40°C				
		410	800	μА	+25°C	V _{DD} = 1.8V ⁽⁴⁾			
		410	830	μА	+85°C	Regulator Disabled			
		700	1500	μА	+125°C				
	All devices	680	990	μА	-40°C		F000 - 4 MUI-		
		680	960	μА	+25°C	$V_{DD} = 3.3V^{(4)}$	Fosc = 1 MHz (RC_RUN mode,		
		670	950	μА	+85°C	Regulator Disabled	HF-INTOSC)		
		800	1700	μА	+125°C				
	All devices	760	1400	μА	-40°C				
		780	1400	μА	+25°C	V _{DD} = 5V ⁽⁵⁾			
		800	1500	μА	+85°C	Regulator Enabled			
		1200	2400	μΑ	+125°C				

- Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or Vss, and all features that add delta current are disabled (such as WDT, SOSC oscillator, BOR, etc.).
 - 2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

 $\underline{\mathsf{OSC1}}$ = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; $\overline{\mathsf{MCLR}}$ = VDD; WDT enabled/disabled as specified.

- 3: Standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.
- 4: Voltage regulator disabled (ENVREG = 0, tied to Vss, RETEN (CONFIG1L<0>) = 1).
- 5: Voltage regulator enabled (ENVREG = 1, tied to VDD, SRETEN (WDTCON<4>) = 1 and RETEN (CONFIG1L<0>) = 0).
- 6: LCD glass is not connected; resistor current is not included.
- 7: 48 MHz maximum frequency at 125°C.

31.5 AC (Timing) Characteristics

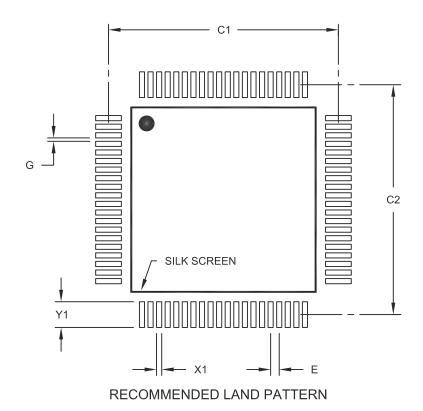
31.5.1 TIMING PARAMETER SYMBOLOGY

The timing parameter symbols have been created following one of the following formats:

1. TppS2ppS		3. Tcc:st	(I ² C specifications only)
2. TppS		4. Ts	(I ² C specifications only)
Т			
F	Frequency	Т	Time
Lowercas	Lowercase letters (pp) and their meanings:		
рр			
СС	CCP1	osc	OSC1
ck	CLKO	rd	RD
cs	CS	rw	RD or WR
di	SDI	sc	SCK
do	SDO	SS	SS
dt	Data in	t0	T0CKI
io	I/O port	t1	T1CKI
mc	MCLR	wr	WR
Uppercas	e letters and their meanings:		
S			
F	Fall	Р	Period
Н	High	R	Rise
1	Invalid (High-Impedance)	V	Valid
L	Low	Z	High-Impedance
I ² C only			
AA	output access	High	High
BUF	Bus free	Low	Low
TCC:ST (I ²	C specifications only)		
CC			
HD	Hold	SU	Setup
ST			
DAT	DATA input hold	STO	Stop condition
STA	Start condition		

80-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch			0.50 BSC	
Contact Pad Spacing	C1		13.40	
Contact Pad Spacing	C2		13.40	
Contact Pad Width (X80)	X1			0.30
Contact Pad Length (X80)	Y1			1.50
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2092A